



				VAR	IATIONS				
	AA			AB					
SYMBOL	MIN	NOMINAL	MAX	MIN ·	NOMINAL	MAX	MIN	NOMINAL	MAX
Α	32.26	32.77	33.27	28.45	28.70	28.96			
A3	7.24		7.75	7.24		7.75			1
A4	7.8			7.8					
A 5	7.8			7.8					
A6	0.05		0.35	0.05		0.35			1
D	109.98	110.24	110.49	109.98	110.24	110.49			
D1	104.64 REF		104.64 REF						
D2	102.86BSC		102.86BSC						
D3	54.61	54.86	55.12	54.61	54.86	55.12			
D4	49.53	49.78	50.04	49.53	49.78	50.04			
e1/e3	52.07BSC		52.07BSC					-	
e2/e4	46.99BSC		46.99BSC						
N	160		160						
ISSUE									
Ref	14-027		14-027						

JEDEC	TITLE DUAL INLINE MEMORY MODULE (DIMM) FAMILY 1.27 LEAD CENTERS,160 LDS	ISSUE	DATE	ITEM	SHEET
SOLID STATE PRODUCT OUTLINE		Α	12/96	MO-191	3 OF 4

NOTES:

- 1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. TOLERANCES ON ALL DIMENSIONS ±.15 UNLESS OTHERWISE SPECIFIED.
- 3. ALL DIMENSIONS ARE IN MILLIMETERS.
- 4. DIMENSION APPLICABLE WHEN COMPONENTS ARE MOUNTED ON ONE SIDE.
- 5. DIMENSIONS APPLICABLE WHEN COMPONENTS MOUNTED ON BOTH SIDES.
- 6. CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALIZATION.
- 7. N IS THE NUMBER OF CIRCUIT TABS (CONTACTS).
- 8. APPLICATION NOTE:
 GOLD CONTACT PAD: GOLD PLATING 0.76um MIN.
 OVER Ni PLATING 2um MIN.

JEDEC	TITLE DUAL INLINE MEMORY	ISSUE	DATE	ІТЕМ	SHEET
SOLID STATE PRODUCT OUTLINE	MODULE (DIMM) FAMILY 1.27 LEAD CENTERS,160 LEADS	A	42 /96	MO-191	4 OF 4